

TIQ-99230enL

# **Application Memo Tin in Solder Plating Fluid**

Industry Inorganic chemical industry
Instrument Automatic potentiometric titrator

Measurement method Redox titration

Standards

#### 1. Overview

Quantification of tin in solder plating fluid is started first by preparing pure water and 6mol/L HCl in a beaker. Then, add potassium sodium tartrate tetrahydrate to dissolve, and add sodium hydrogen carbonate, where just after the test sample is added, titration goes with the 0.05mol/L iodine solution up to the endpoint, which is the maximum inflexion on the titration curve. The tin concentration is calculated from the titration volume of the iodine solution.

#### 2. Apparatus

Main unit Automatic potentiometric titrator (preamplifier STD)

Electrode Platinum electrode, Ceramic reference electrode

### 3. Reagents

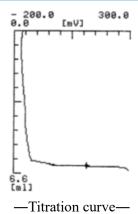
Titrant 0.05 mol/L (0.1 N) Iodine

Additive 6mol/L hydrochloric acid, Potassium sodium tartrate tetrahydrate,

Sodium hydrogen carbonate

Solvent Pure water

## 4. Example



	Sample	Titer	Tin
	(mL)	(mL)	(g/L)
1	1.0	6.2891	37.55
2	1.0	6.2428	37.27
3	1.0	6.2788	37.49
4	1.0	6.1783	36.89
5	1.0	6.2363	37.24
Average			37.29
SD			0.26
RSD(%)			0.70

—Measurement results—

Please feel free to contact us for any further information.

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